

## SPECIFICATION FOR APPROVAL

CUSTOMER	:	
PRODUCT TYPE	:	SMD SEAM SEALING X'TAL 1.6× 1.2
NOMINAL FREQ.	:	32.000000MHz
EAS P/N	:	EAS1612SA32.00080BJR3
REVISION	:	S1
CUSTOMER P/N	:	
PM / SALES	:	
DATE	:	
CUSTOMER SIGNAT	UR	E & Date

- (1) EAS requires one copy returned with signature and title of authorized individual that signifies acceptance of the attached specifications.
- (2) Orders received and accepted by EAS after return of signed copy of specification will be produced per these specifications.
- (3) Any changes to these specifications must be agreed upon by both parties and new revision of the Product Specification Sheet will be issued.
- (4) Any issuance of purchase order prior to consigning back the Approval page of "Specification Sheets" from customers will be regarded as the agreement on the contents of these specifications.

Attachment: Product Specification Sheet

1

2

3

4

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**RoHS Compliant** 





# PRODUCT SPECIFICATION SHEET

PRODUCT TYPE : SMD SEAM SEALING X'TAL 1.6× 1.2

NOMINAL FREQ. : 32.000000MHz

EAS P/N : EAS1612SA32.00080BJR3

REVISION : S1

PE/RD	QA	MFG

#### NOTE:

(1)The green product standard set by EAS is based upon the international standards. Related information is publicly described on the EAS's Website, and updated regularly. The document is compliant with the latest green product quality system directives at the time.

- (2)Revision "Sx" is for engineering samples only. PE/RD's approval required.
- (3)Revision "Ax" is production ready. PE, QA and MFG's approval required

**RoHS Compliant** 

EAS CORPORATION EAS P/N: EAS1612SA32.00080BJR3 S1

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<u>Rev</u>	Revise page	Revise contents	<u>Date</u>	Ref.No.	<u>Reviser</u>

# **Spec Sheet Contents**

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#### **■ ELECTRICAL SPECIFICATIONS**

#### Standard atmospheric conditions

Unless otherwise specified, the standard range of atmospheric conditions for making measurement and tests are as follow:

Ambient temperature :  $25\pm10\,^{\circ}\text{C}$ Relative humidity : 40%-70%

If there is any doubt about the results, measurement shall be made within the following limits:

Ambient temperature :  $25\pm3$  °C Relative humidity :  $40\%\sim70\%$ 

#### Measure equipment

Electrical characteristics measured by S&A250B or equivalent.

#### Crystal cutting type

The crystal is using AT CUT (thickness shear mode).

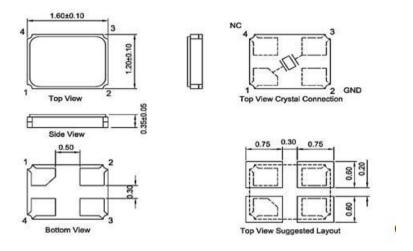
#### **Unit Weight:**

0.005±0.002 g/pcs

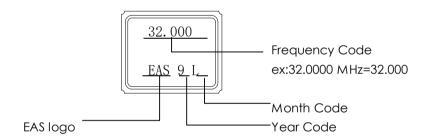
	Parameters	C. mala al	Electrical Spec.				Notes
	Parameters	Symbol	Min.	Тур.	Max.	Units	Notes
1	Nominal Frequency	FL	3	32.000000	)	MHz	-
2	Oscillation Mode	-	F	undament	al	-	-
3	Load Capacitance	CL		8		pF	-
4	Frequency Tolerance	-		±10		ppm	at 25 ℃ ± 3 ℃
5	Frequency Stability	-		±20		ppm	Over Operating Temp. Range (Reference 25℃)
6	Operating Temperature	-	-20	~	70	$^{\circ}$	-
7	Aging	-		±3		ppm	1st Year
8	Drive Level	DL	-	100	-	uW	-
9	Equivalent Series Resistance	Rr	-	-	60	Ω	-
10	Shunt Capacitance C0	C0	1	1	3.5	pF	-
11	Insulation Resistance	-	500	1	1	ΜΩ	at DC 100V
12	Storage Temperature Range	-	-40	~	105	$^{\circ}$ C	-

#### **■ DIMENSIONS**

(Unit:mm)



#### **■** MARKING



### Year Code:

2010	2011	2012	2013	2014	2015	2016	2017	2018	2019	2020	2021
0	1	2	3	4	5	6	7	8	9	0	1

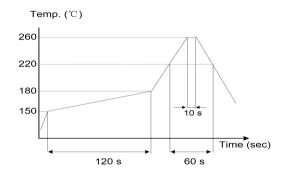
#### Month Code:

JAN	FEB	MAR	APR	MAY	JUN	JUL	AUG	SEP	OCT	NOV	DEC
Α	В	С	D	Е	F	G	Н	1	J	K	L

## **Production location: CHINA**

#### ■ SUGGESTED REFLOW PROFILE

Total time : 200 sec. Max. Solder melting point :220  $^{\circ}$ C



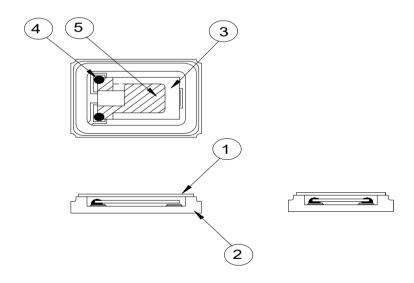
## ■ SUGGESTED MANUAL SOLDER CONDITION

Temperature: 350 ± 10  $^{\circ}$ C

Time: 3 sec.

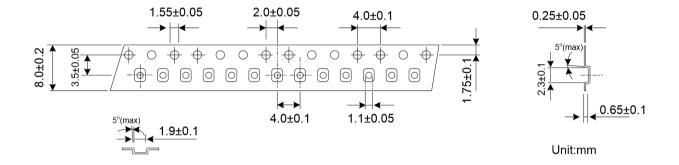
Re-solder times: twice

## ■ STRUCTURE ILLUSTRATION

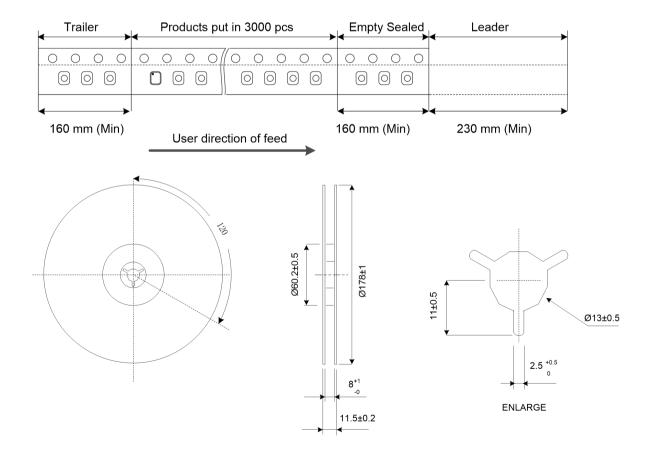


NO	COMPONENTS	MATERIALS	FINISH/SPECIFICATIONS
1	Lid	Kovar (Fe/Co/Ni)	-
2	Base(Package)	Ceramic (Al <sub>2</sub> O <sub>3</sub> ) + Kovar (Fe/Co/Ni)+Pad(Au)	Tungsten metalize
3	Crystal blank	SiO <sub>2</sub>	-
4	Conductive adhesive	Resin+Ag	-
5	Electrode	Noble Metal	-

#### **■ PACKING**



#### REMARK:



Standard Reel Quantity is 3,000 pcs per reel

#### **■ RELIABILITY SPECIFICATIONS**

## 1.Mechanical Endurance

No.	Test Item	Test Me	ethods	Test Criteria
1.1	Drop Test	150 cm height, 3 times on concrete flo	oor.	A.C
1.2	Mechanical Shock	Device are shocked to half sine wave	۸ . ۲	
1.2	iviechanicai Shock	perpendicular axes each 3 times. 0.5r	m sec. duration time	A.C
		Frequency range	10 ~ 2000 Hz	
		Amplitude	1.52 mm/20G	
1.3	Vibration	Sweep time	20 minutes	A.C
		perpendicular axes each test time	4 Hrs	
			(Total test time 12 Hrs)	
1.4	Gross Leak	Standard Sample For Automatic Gros 2kg / cm <sup>2</sup>	s Leak Detector, Test Pressure:	F
1.5	Fine Leak	Helium Bombing 4.5 kg/ cm <sup>2</sup> for 2 Hr	s	G
		Temperature	240 °C ± 5°C	
		Immersing depth	0.5 mm minimum	
1.6	Solder ability	Immersion time	5 ± 1 seconds	E
		Flux	Rosin resin methyl alcohol	
			solvent (1:4)	

## 2. Environmental Endurance

No.	Test Item	Test Methods	Test Criteria
		Pre-heat temperature 125 °C	
21	Resistance To Soldering Heat	Pre-heat time 60 ~ 120 sec.	B.C.D
2	recoloration to coldoning float	Test temperature 260 ± 5 ℃	D. O. D
		Test time 10 ± 1 sec.	
2.2	High Temp. Storage	+ 125 °C ± 3 °C for 500 ± 12 Hrs	B.C.D
2.3	Low Temp. Storage	- 40 °C ± 3 °C for 500 ± 12 Hrs	B.C.D
2.4	Temperature cycle	Total 100 cycles of the following temperature cycle $\begin{array}{c ccccccccccccccccccccccccccccccccccc$	B.C.D
2.5	High Temp & Humidity	85°C ± 3°C, RH 85% , 500Hrs	B.C.D

#### **RELIABILITY SPECIFICATIONS**

	Specifications
А	Frequency change: Within ±5ppm or in customer's specification.
В	Frequency change: Within ±10ppm or in customer's specification.
С	Equivalent series resistance(E.S.R) change: Within $\pm 15\%$ or $10\Omega(larger\ value)$ .
D	After conditioning , quartz crystal units shall be subjected to standard atmospheric conditions for 2 hour, and measured.
Е	Minimum 95% of immersed terminal shall be covered with new uniform solder.
F	Leak rate< 1×10 <sup>-5</sup> Pa*m³/Sec
G	Leak rate< 4×10 <sup>-9</sup> Pa*m³/Sec

## **Measurement condition**

Electrical characteristics measured by S&A250B or equivalent.